



✓ CHECK PIN 1
DIE ORIENTATION
WITH RESPECT
TO WAFER FLAT

LEADFRAME: LF1-H128-201

D/A PAD SIZE: 9.5mm X 9.5mm

SCALE: DO NOT SCALE DRAWING

REV.	REV.	DESCRIPTION	DATE	DRAWN:	DATE:
00-101	A	NEW DRAWING	10/01/00	Louis Rezonable	08/09/2000
00-100	B	CHANGING SCALE TO 1X	08/04/00	George Fujimoto	08/09/2000
				APPROVED:	DATE:
				APPROVED:	DATE:
				DWG. NUMBER: QFP-ED-14SQ-128-01	
				ACAD FILENAME: 81281401.DWG	

TITLE:

BOND SHELL - 14X14X1.4/2.0 QFP, 128 LD



2221 Old Oakland Road
San Jose, CA 95131-1402
Phone: (408)321-3600
Fax: (408)321-3603